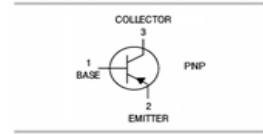




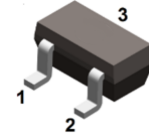
Features

- Epitaxial planar die construction
- Complement to MMBT4401T



Mechanical Data

- Case: SOT-523
- Molding Compound: UL Flammability Classification Rating 94V-0
- Terminals: Matte tin-plated leads; solderability-per MIL-STD-202, Method 208



SOT-523

Ordering Information

Part Number	Package	Shipping Quantity	Marking Code
MMBT4403T	SOT-523	3000 pcs / Tape & Reel	2T

Maximum Ratings (@ T_A = 25°C unless otherwise specified)

Parameter	Symbol	Value	Unit
Collector-Base Voltage	V _{CB0}	-40	V
Collector-Emitter Breakdown Voltage	V _{CEO}	-40	V
Emitter-Base Breakdown Voltage	V _{EBO}	-5	V
Collector Current (Continuous)	I _C	-0.6	A
Collector Current (Peak)	I _{CM}	-1.2	A

Thermal Characteristics

Parameter	Symbol	Value	Unit
Power Dissipation ^{*1}	P _D	0.15	W
Thermal Resistance Junction-to-Air ^{*1}	R _{θJA}	833	°C/W
Thermal Resistance Junction-to-Air ^{*2}	R _{θJA}	125	°C/W
Thermal Resistance Junction-to-Case ^{*2}	R _{θJC}	70	°C/W
Thermal Resistance Junction-to-Lead ^{*2}	R _{θJL}	50	°C/W
Operating Junction Temperature	T _J	-55 ~ +150	°C
Storage Temperature Range	T _{STG}	-55 ~ +150	°C



Electrical Characteristics (@ T_A = 25°C unless otherwise specified)

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Collector-Base Breakdown Voltage	V _{(BR)CBO}	I _C = -100μA, I _E = 0	-40	-	-	V
Collector-Emitter Breakdown Voltage	V _{(BR)CEO}	I _C = -1mA, I _B = 0	-40	-	-	V
Emitter-Base Breakdown Voltage	V _{(BR)EBO}	I _E = -100μA, I _C = 0	-5	-	-	V
Collector Cut-off Current	I _{CBO}	V _{CB} = -35V, I _E = 0	-	-	-0.1	μA
Collector Cut-off Current	I _{CEX}	V _{CE} = -35V, V _{EB(OFF)} = -0.4V	-	-	-0.1	μA
Base Cut-off Current	I _{BL}	V _{CE} = -35V, V _{EB(OFF)} = -0.4V	-	-	-0.1	μA
DC Current Gain	h _{FE}	V _{CE} = -1V, I _C = -0.1mA	30	-	-	-
		V _{CE} = -1V, I _C = -1mA	60	-	-	-
		V _{CE} = -1V, I _C = -10mA	100	-	-	-
		V _{CE} = -2V, I _C = -150mA	100	-	300	-
		V _{CE} = -2V, I _C = -500mA	20	-	-	-
Collector-emitter Saturation Voltage	V _{CE(sat)}	I _C = -150mA, I _B = -15mA	-	-	-0.4	V
		I _C = -500mA, I _B = -50mA	-	-	-0.75	V
Base-emitter Saturation Voltage	V _{BE(sat)}	I _C = -150mA, I _B = -15mA	-0.75	-	-0.95	V
		I _C = -500mA, I _B = -50mA	-	-	-1.30	V
Current-Gain—Bandwidth Product	f _T	V _{CE} = -10V, I _C = -20mA f = 100MHz	200	-	-	MHz

Notes:

1. Device mounted on a minimum recommended pad layout with 1oz copper that is on a single-sided 1.6mm FR4 PCB; the device is measured under still air conditions whilst operating in a steady-state.
2. The data tested by surface mounted on a 25.4mm * 25.4mm * 1mm FR4-epoxy P.C.B



Ratings and Characteristic Curves (@ $T_A = 25^\circ\text{C}$ unless otherwise specified)

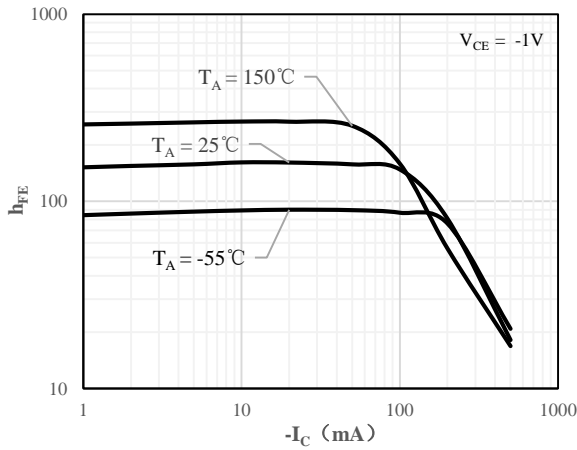


Fig 1 h_{FE} vs. I_C

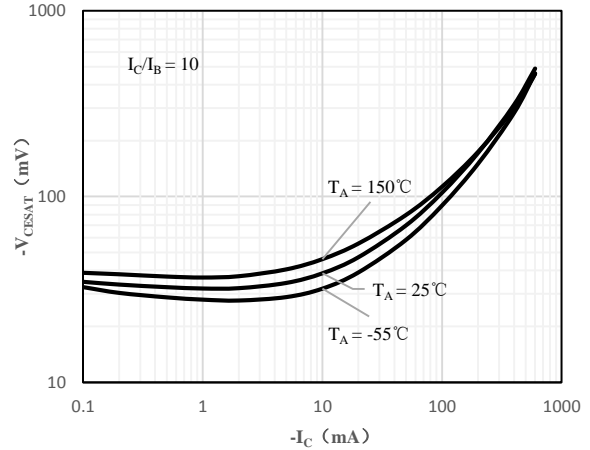


Fig 2 $V_{CE(sat)}$ vs. I_C

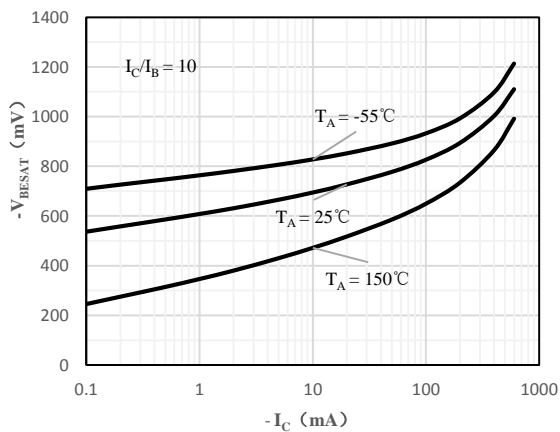


Fig 3 $V_{BE(sat)}$ vs. I_C

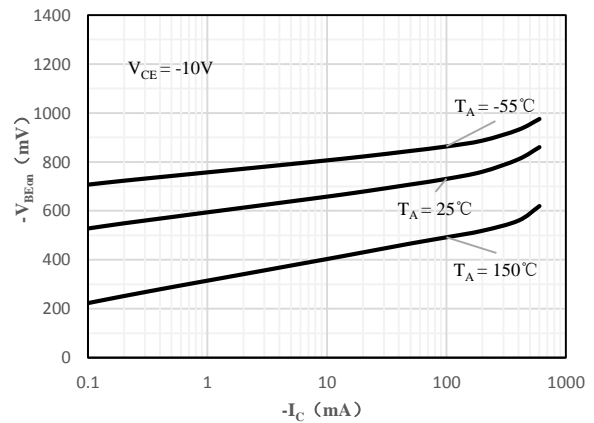
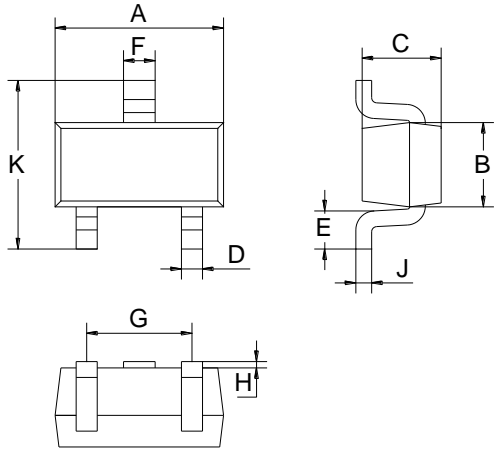


Fig 4 $V_{BE(on)}$ vs. I_C



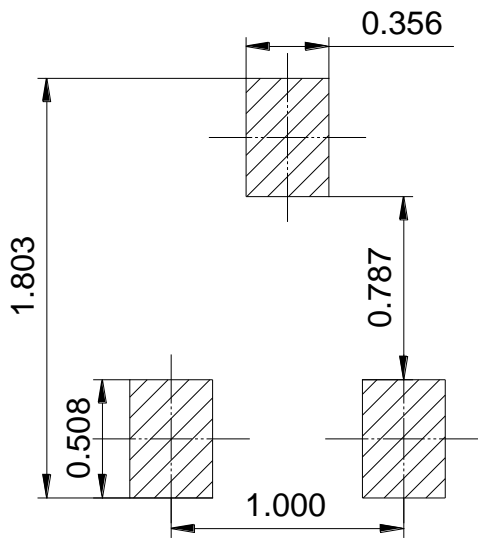
Package Outline Dimensions (Unit: mm)



SOT-523		
Dimension	Min.	Max.
A	1.50	1.70
B	0.75	0.85
C	0.60	0.80
D	0.15	0.30
E	0.30	0.40
F	0.25	0.40
G	0.90	1.10
H	0.02	0.10
J	0.08	0.18
K	1.45	1.75

Mounting Pad Layout (Unit: mm)

SOT-523



Package	Reel	Reel Size	Box	Box Size(mm)	Carton	Carton Size(mm)
SOT -523	3000pcs	7inch	45,000pcs	203×203×195	180,000pcs	438×438×220
SOT -523	8000pcs	7inch	120,000pcs	203×203×195	480,000pcs	438×438×220